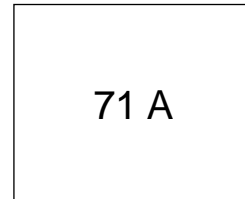



## IRK.F72.. SERIES

**FAST THYRISTOR/ DIODE and  
 THYRISTOR/THYRISTOR**

**INT-A-pak™ Power Modules**



### Features

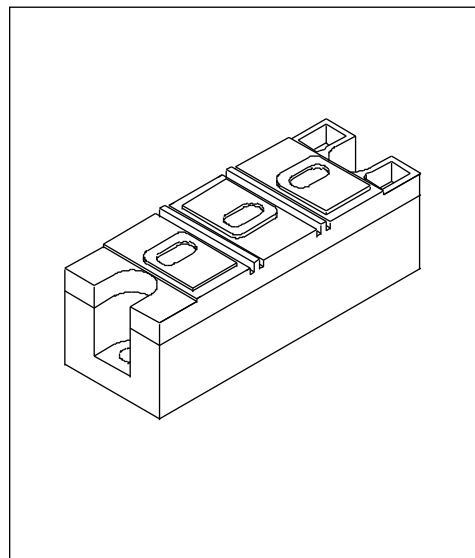
- Fast turn-off thyristor
- Fast recovery diode
- High surge capability
- Electrically isolated baseplate
- 3000 V<sub>RMS</sub> isolating voltage
- Industrial standard package
- UL E78996 approved 

### Description

These series of INT-A-pak modules are intended for applications such as self-commutated inverters, DC choppers, electronic welders, induction heating and others where fast switching characteristics are required.

### Major Ratings and Characteristics

Parameters	IRK.F72..	Units
$I_{T(AV)}$	71	A
@ $T_C$	90	°C
$I_{T(RMS)}$	158	A
$I_{TSM}$ @ 50Hz	2100	A
@ 60Hz	2200	A
$I^2t$ @ 50Hz	21.6	KA <sup>2</sup> s
@ 60Hz	19.8	KA <sup>2</sup> s
$I^2\sqrt{t}$	216	KA <sup>2</sup> √s
$t_q$	20 and 25	μs
$t_{rr}$	2	μs
$V_{DRM}/V_{RRM}$	upto 1200	V
$T_J$ range	-40 to 125	°C



## IRK.F72.. Series

Bulletin I27104 rev. A 09/97

International  
**IR** Rectifier

### ELECTRICAL SPECIFICATIONS

#### Voltage Ratings

Type number	Voltage Code	$V_{RRM}/V_{DRM}$ , maximum repetitive peak reverse voltage V	$V_{RSM}$ , maximum non-repetitive peak rev. voltage V	$I_{RRM}/I_{DRM}$ max. @ $T_J = 125^\circ\text{C}$ mA
IRK.F72..	08	800	800	30
	12	1200	1200	

#### Current Carrying Capacity

Frequency f				Units			
50Hz	140	230	220	345	1860	2590	A
400Hz	170	280	250	406	900	1290	A
2500Hz	135	210	210	330	320	470	A
5000Hz	115	180	205	310	205	310	A
10000Hz	85	140	165	235	-	-	A
Recovery voltage Vr	50	50	50	50	50	50	V
Voltage before turn-on Vd	80% $V_{DRM}$		80% $V_{DRM}$		80% $V_{DRM}$		V
Rise of on-state current di/dt	50	50	-	-	-	-	A/ $\mu\text{s}$
Case temperature	90	60	90	60	90	60	$^\circ\text{C}$
Equivalent values for RC circuit	22 $\Omega$ / 0.15 $\mu\text{F}$		22 $\Omega$ / 0.15 $\mu\text{F}$		22 $\Omega$ / 0.15 $\mu\text{F}$		

#### On-state Conduction

Parameter	IRK.F72..	Units	Conditions
$I_{T(AV)}$ Maximum average on-state current @ Case temperature	71	A	180° conduction, half sine wave
	90	$^\circ\text{C}$	
$I_{T(RMS)}$ Maximum RMS current	158	A	$T_C = 90^\circ\text{C}$ , as AC switch
$I_{TSM}$ Maximum peak, one-cycle, non-repetitive surge current	2100	A	t = 10ms No voltage reappplied
	2200		t = 8.3ms No voltage reappplied
	1750		t = 10ms 100% $V_{RRM}$ reappplied
	1830		t = 8.3ms 100% $V_{RRM}$ reappplied
$I^2t$ Maximum $I^2t$ for fusing	21.6	$\text{KA}^2\text{s}$	t = 10ms No voltage reappplied
	19.8		t = 8.3ms reappplied
	15.3		t = 10ms 100% $V_{RRM}$ reappplied
	14.0		t = 8.3ms reappplied
$I^2\sqrt{t}$ Maximum $I^2\sqrt{t}$ for fusing	216	$\text{KA}^2\sqrt{\text{s}}$	t = 0 to 10ms, no voltage reappplied
$V_{T(TO)1}$ Low level value of threshold voltage	1.28	V	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$ , $T_J = T_J \text{ max.}$
$V_{T(TO)2}$ High level value of threshold voltage	1.32		$(I > \pi \times I_{T(AV)})$ , $T_J = T_J \text{ max.}$
$r_{t1}$ Low level value of on-state slope resistance	3.20	mW	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)})$ , $T_J = T_J \text{ max.}$
$r_{t2}$ High level value of on-state slope resistance	3.00		$(I > \pi \times I_{T(AV)})$ , $T_J = T_J \text{ max.}$
$V_{TM}$ Maximum on-state voltage drop	2.40	V	$I_{pk} = 350\text{A}$ , $T_J = T_J \text{ max.}$ , $t_p = 10\text{ms}$ sine pulse
$I_H$ Maximum holding current	600	mA	$T_J = 25^\circ\text{C}$ , $I_T > 30\text{A}$
$I_L$ Typical latching current	1000	mA	$T_J = 25^\circ\text{C}$ , $V_A = 12\text{V}$ , $R_a = 6\Omega$ , $I_g = 1\text{A}$

**Switching**

Parameter	IRK.F72..	Units	Conditions
di/dt Maximum non-repetitive rate of rise	800	A/μs	Gate drive 20V, 20Ω, tr ≤ 1ms, V <sub>D</sub> = 80% V <sub>DRM</sub> T <sub>J</sub> = 125°C
t <sub>TR</sub> Maximum recovery time	2	μs	I <sub>TM</sub> = 350A, di/dt = -25A/μs, V <sub>R</sub> = 50V, T <sub>J</sub> = 25°C
t <sub>q</sub> Maximum turn-off time	K 20	J μs	I <sub>TM</sub> = 350A, T <sub>J</sub> = 125°C, di/dt = -25A/μs, V <sub>R</sub> = 50V, dv/dt = 400V/μs linear to 80% V <sub>DRM</sub>

**Blocking**

Parameter	IRK.F72..	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	1000	V/μs	T <sub>J</sub> = 125°C., exponential to = 67% V <sub>DRM</sub>
V <sub>INS</sub> RMS isolation voltage	3000	V	50 Hz, circuit to base, T <sub>J</sub> = 25°C, t = 1 s
I <sub>RRM</sub> Maximum peak reverse and off-state leakage current I <sub>DRM</sub>	30	mA	T <sub>J</sub> = 125°C, rated V <sub>DRM</sub> /V <sub>RRM</sub> applied

**Triggering**

Parameter	IRK.F72..	Units	Conditions
P <sub>GM</sub> Maximum peak gate power	60	W	f = 50 Hz, d% = 50
P <sub>G(AV)</sub> Maximum peak average gate power	10	W	T <sub>J</sub> = 125°C, f = 50Hz, d% = 50
I <sub>GM</sub> Maximum peak positive gate current	10	A	T <sub>J</sub> = 125°C, t <sub>p</sub> ≤ 5ms
-V <sub>GM</sub> Maximum peak negative gate voltage	5	V	
I <sub>GT</sub> Max. DC gate current required to trigger	200	mA	T <sub>J</sub> = 25°C, V <sub>ak</sub> 12V, Ra = 6
V <sub>GT</sub> DC gate voltage required to trigger	3	V	
I <sub>GD</sub> DC gate current not to trigger	20	mA	T <sub>J</sub> = 125°C, rated V <sub>DRM</sub> applied
V <sub>GD</sub> DC gate voltage not to trigger	0.25	V	

**Thermal and Mechanical Specifications**

Parameter	IRK.F72..	Units	Conditions
T <sub>J</sub> Max. junction operating temperature range	- 40 to 125	°C	
T <sub>stg</sub> Max. storage temperature range	- 40 to 150		
R <sub>thJC</sub> Max. thermal resistance, junction to case	0.17	K/W	Per junction, DC operation
R <sub>thC-hs</sub> Max. thermal resistance, case to heatsink	0.035	K/W	Mounting surface flat and greased Per module
T Mounting torque ± 10%	IAP to heatsink	4 - 6 (35 - 53)	Nm (lb*in)
	busbar to IAP	4 - 6 (35 - 53)	
wt Approximate weight	500 (17.8)	g (oz)	A mounting compound is recommended. The torque should be rechecked after a period of 3 hours to allow for the spread of the compound. Use of cable lugs is not recommended, busbars should be used and restrained during tightening. Threads must be lubricated with a compound

## IRK.F72.. Series

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International  
**IR** Rectifier

### $\Delta R_{thJC}$ Conduction

(The following table shows the increment of thermal resistance  $R_{thJC}$  when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction	Rectangular conduction	Units	Conditions
180°	0.016	0.011	K/W	$T_J = 125^\circ\text{C}$
120°	0.019	0.020		
90°	0.024	0.026		
60°	0.035	0.037		
30°	0.060	0.060		

### Ordering Information Table

Device Code									
IRK	T	F	7	2	-	12	H	K	N
①	②	③	④	⑤		⑥	⑦	⑧	⑨
<b>1</b>	- Module type								
<b>2</b>	- Circuit configuration								
<b>3</b>	- Fast SCR								
<b>4</b>	- Current rating: $I_{T(AV)} \times 10$ rounded								
<b>5</b>	- 1 = option with spacers and longer terminal screws 2 = option with standard terminal screws								
<b>6</b>	- Voltage code: Code $\times 100 = V_{RRM}$ (See Voltage Ratings Table)								
<b>7</b>	- dv/dt code: H $\leq 400\text{V}/\mu\text{s}$								
<b>8</b>	- $t_q$ code: K $\leq 20\mu\text{s}$ J $\leq 25\mu\text{s}$								
<b> </b>	- None = Standard devices								
<b>N</b>	= Aluminum nitride substrate								

**NOTE: To order the Optional Hardware see Bulletin I27900**

Outline Table

- All dimensions in millimeters (inches)
- Dimensions are nominal
- Full engineering drawings are available on request
- UL identification number for gate and cathode wire: UL 1385
- UL identification number for package: UL 94V0

For all types	A	B	C	D	E
IRK...1	25 (0.98)	----	----	41 (1.61)	47 (1.85)
IRK...2	23 (0.91)	30 (1.18)	36 (1.42)	----	----

IRKTF.. IRKHF.. IRKLF.. IRKUF.. IRKV.. IRKVF.. IRKKF.. IRKNF..

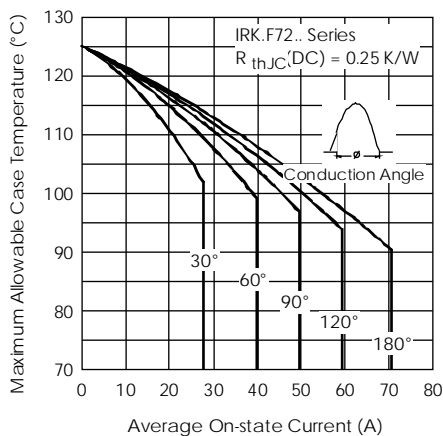


Fig. 1 - Current Ratings Characteristics

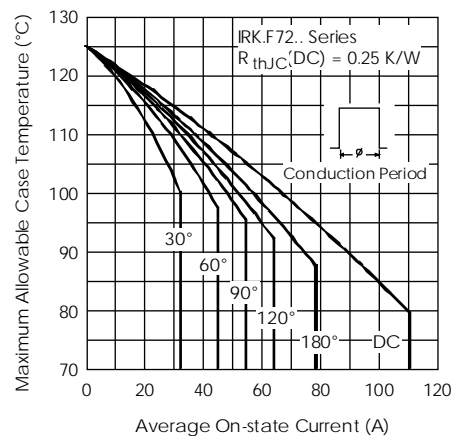


Fig. 2 - Current Ratings Characteristics

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International  
**IR** Rectifier

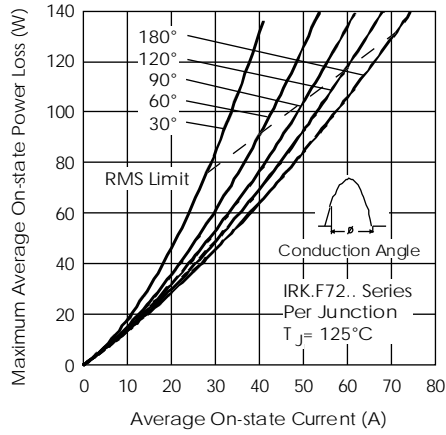


Fig. 3 - On-state Power Loss Characteristics

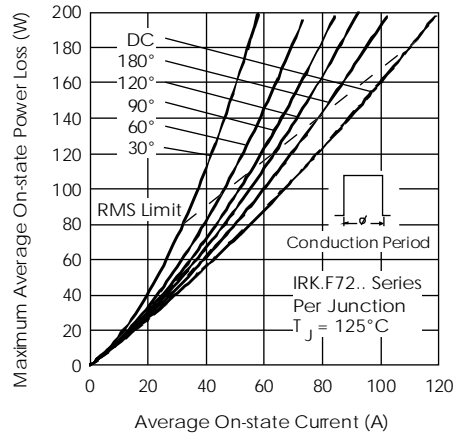


Fig. 4 - On-state Power Loss Characteristics

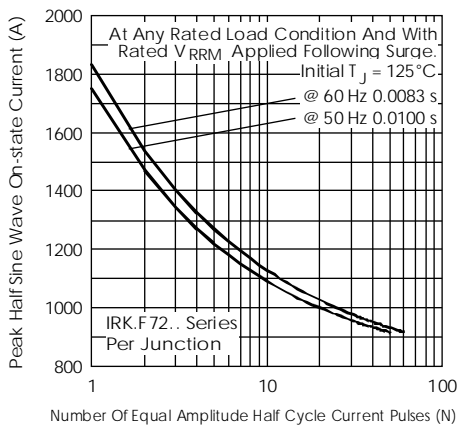


Fig. 5 - Maximum Non-Repetitive Surge Current

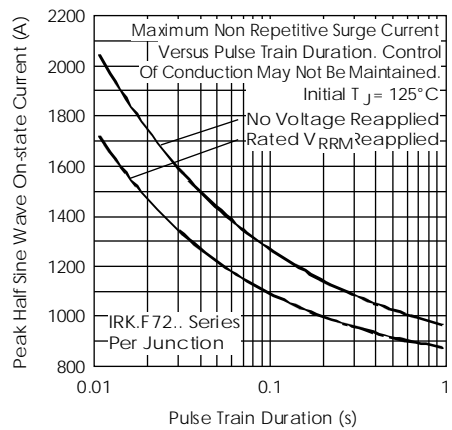


Fig. 6 - Maximum Non-Repetitive Surge Current

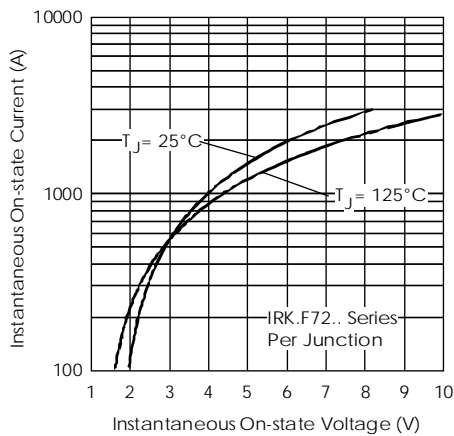


Fig. 7 - On-state Voltage Drop Characteristics

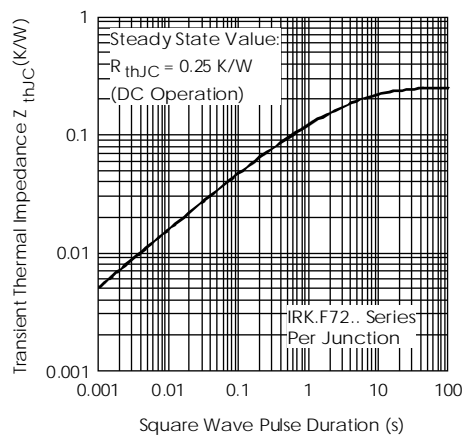


Fig. 8 - Thermal Impedance  $Z_{thJC}$  Characteristic

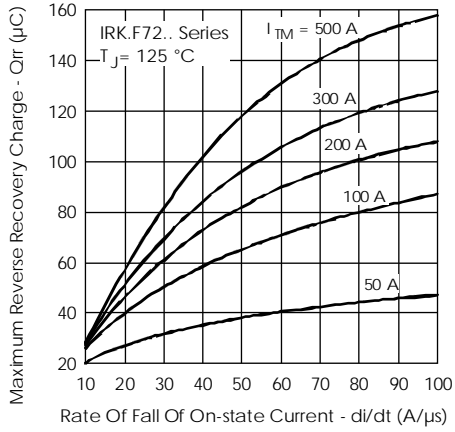


Fig. 9 - Reverse Recovery Charge Characteristic

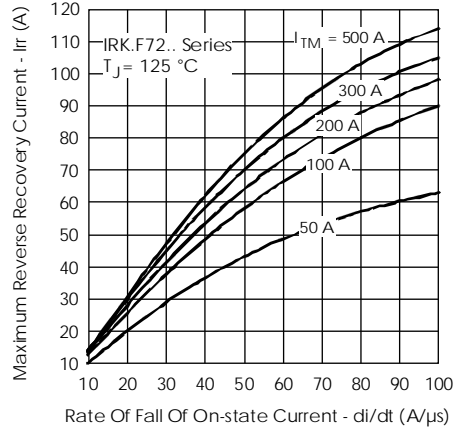


Fig. 10 - Reverse Recovery Current Characteristic

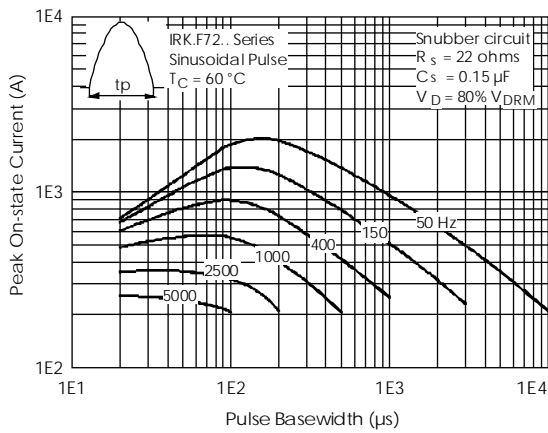


Fig. 11 - Frequency Characteristics

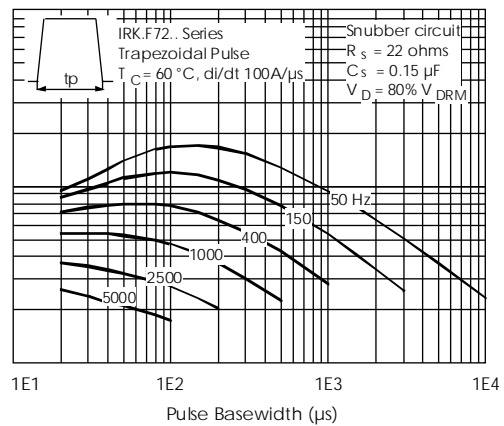
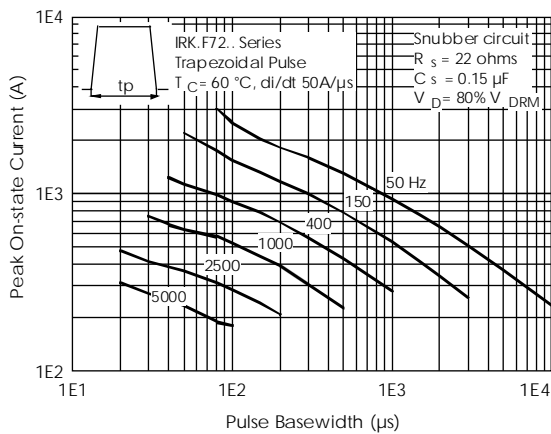
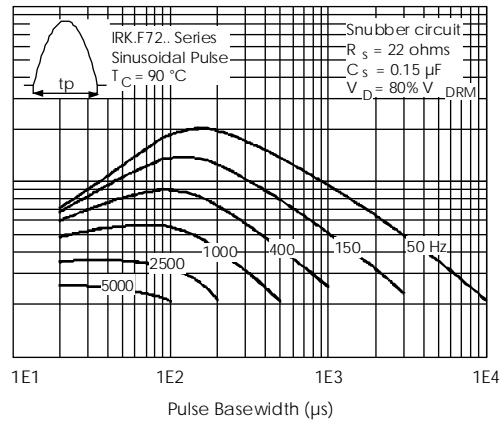


Fig. 12 - Frequency Characteristics

**IRK.F72.. Series**

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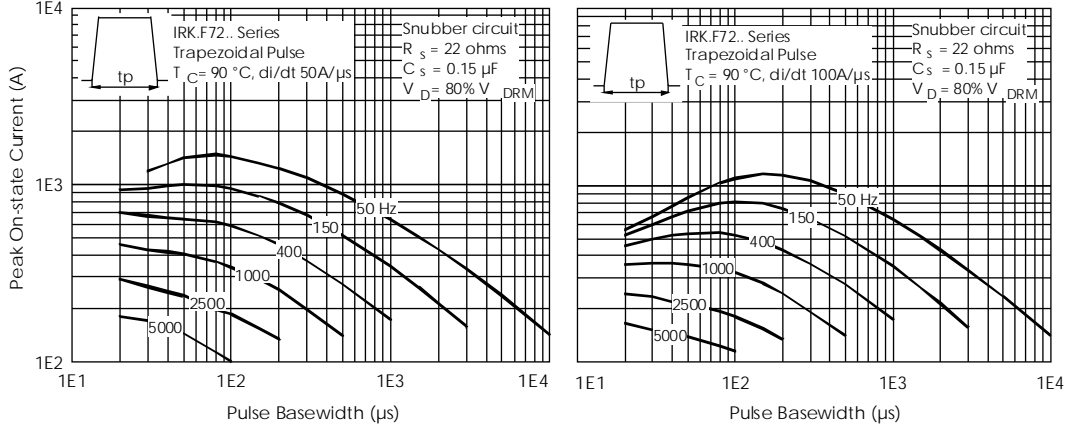


Fig. 13 - Frequency Characteristics

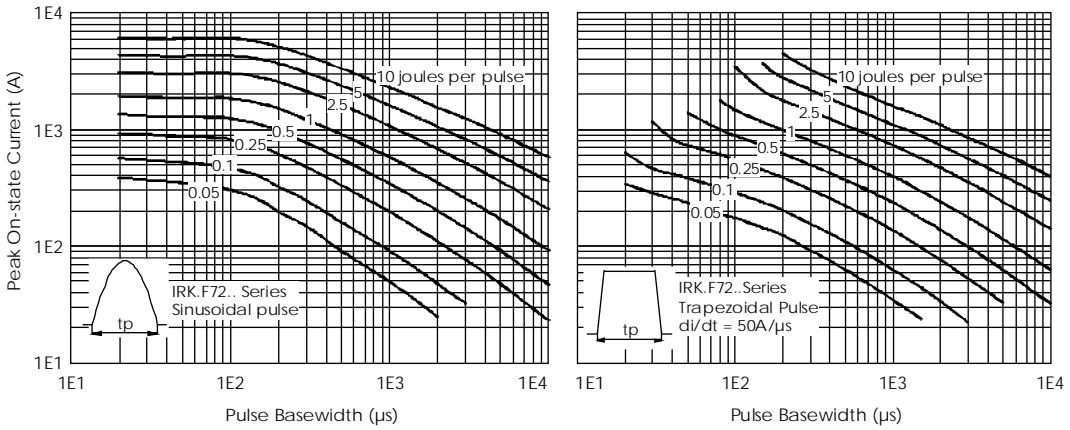


Fig. 14 - Maximum On-state Energy Power Loss Characteristics

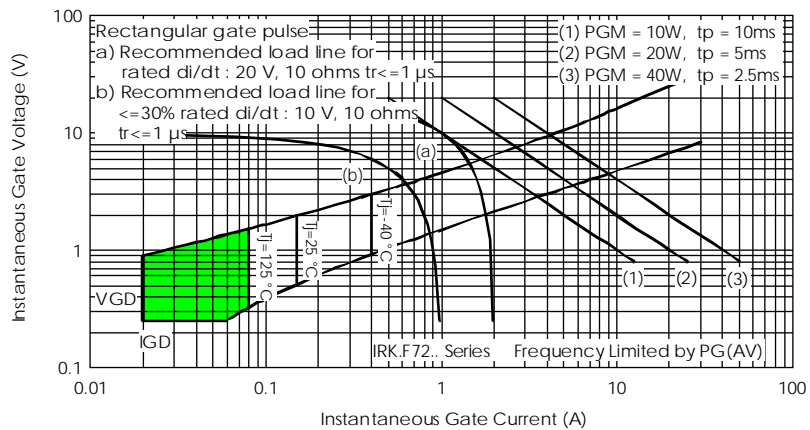


Fig. 15 - Gate Characteristics